



# SDHCAL STATUS

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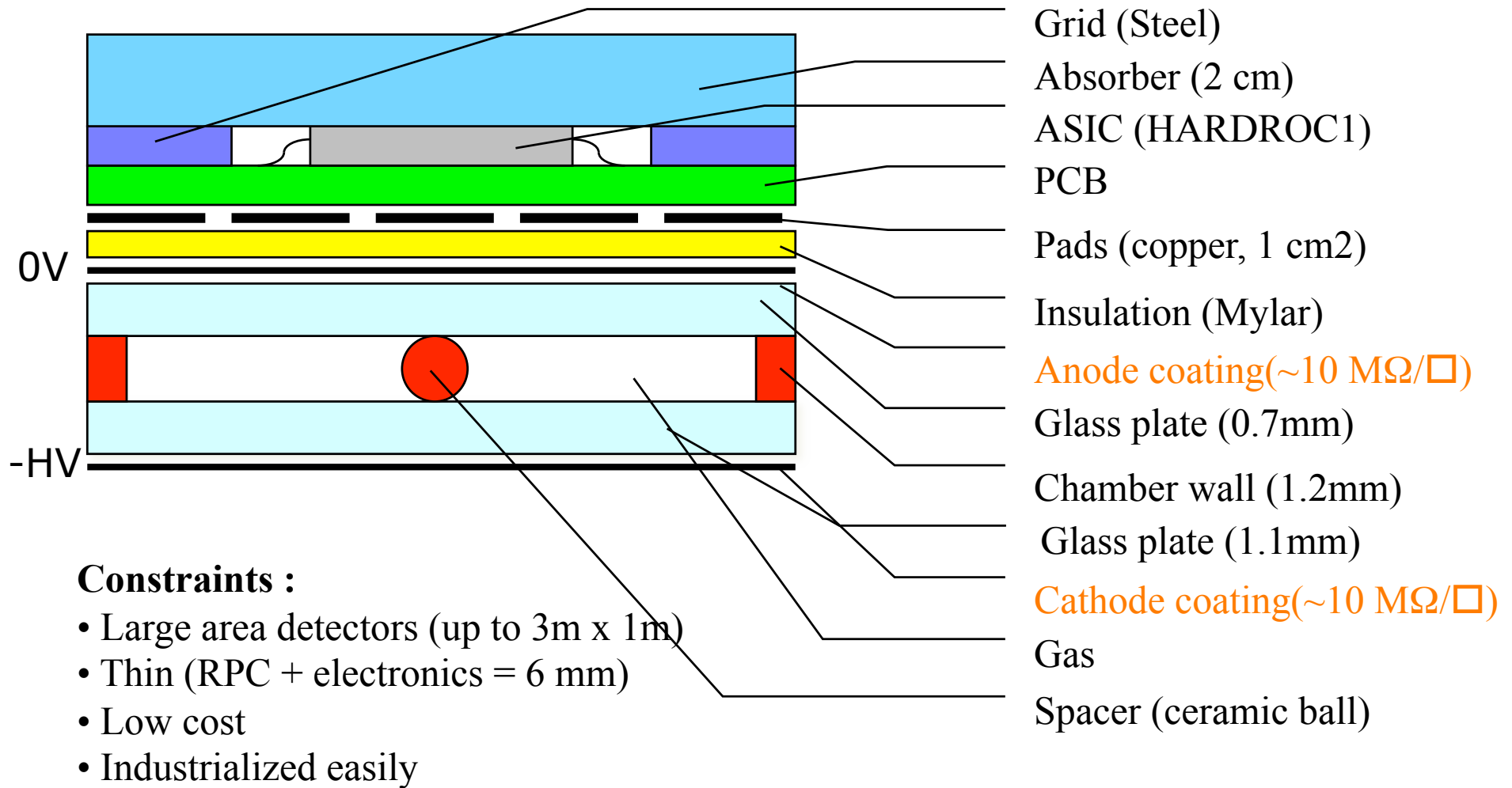
for GRPC-SDHCAL community  
(CIEMAT, Ghent, IPNL, LLR, Louvain, Tsinghua, Tunis)



# Contents

- Status of 1M<sup>2</sup> GRPC R&D
  - Resistive coating
  - Gas
  - DAQ
  - First Results
- Simulation work
- Conclusion

# GRPC and semi-digital calorimeter



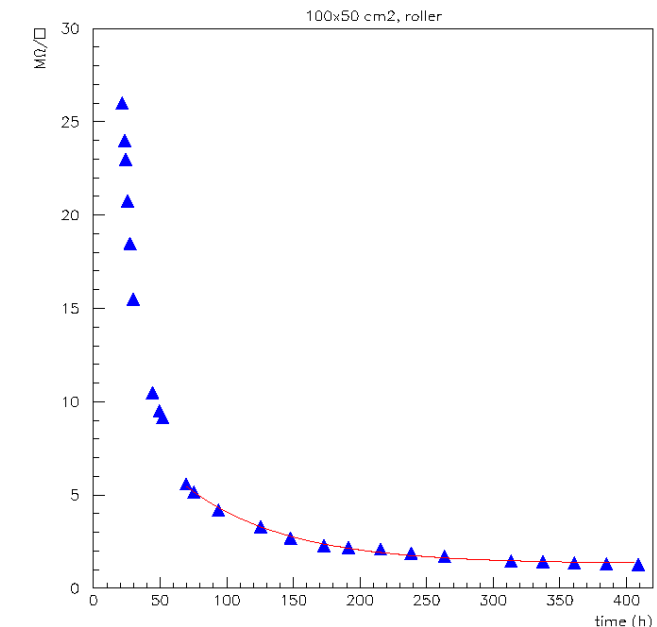
# Semi-conductive paint (1)

- Many chambers successfully built using Statguard product
- Applied to large areas using paint brush up to now
- Recently established industrial contacts to investigate option of silk screen printing
- Covered several m<sup>2</sup> using this method → now build chambers

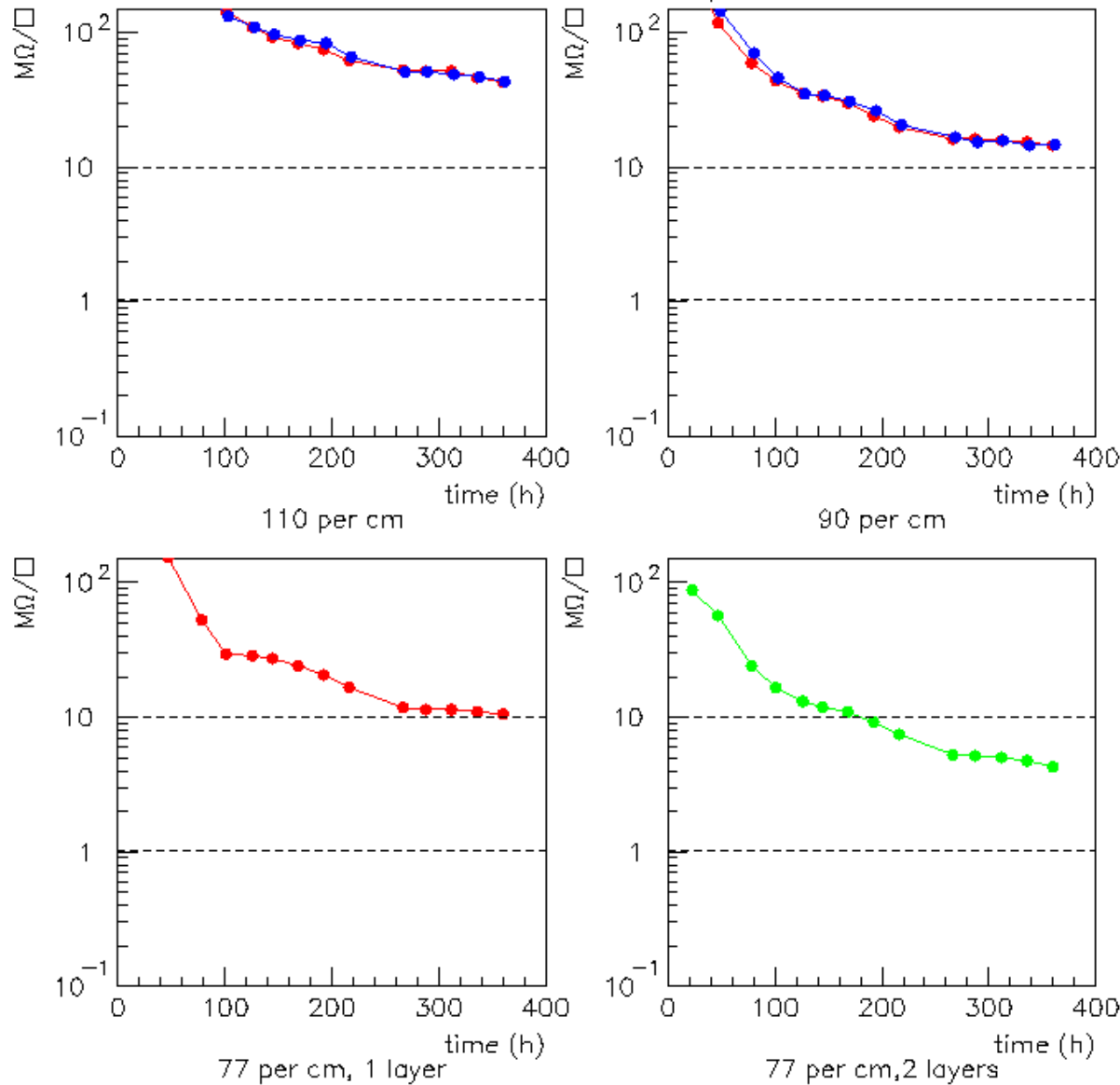


# Semi-conductive paint (2)

- Statguard: disadvantages
  - Not produced specifically for silk screen printing
  - Hard to clean silk screens
  - Long time constant for stable resistivity
  
- Investigating new product: colloidal graphite
  - Very stable resistivity
  - Specifically produced for silk-screen printing
  - BUT needs large oven or UV curing facilities



# Statguard time stability - different layer thicknesses

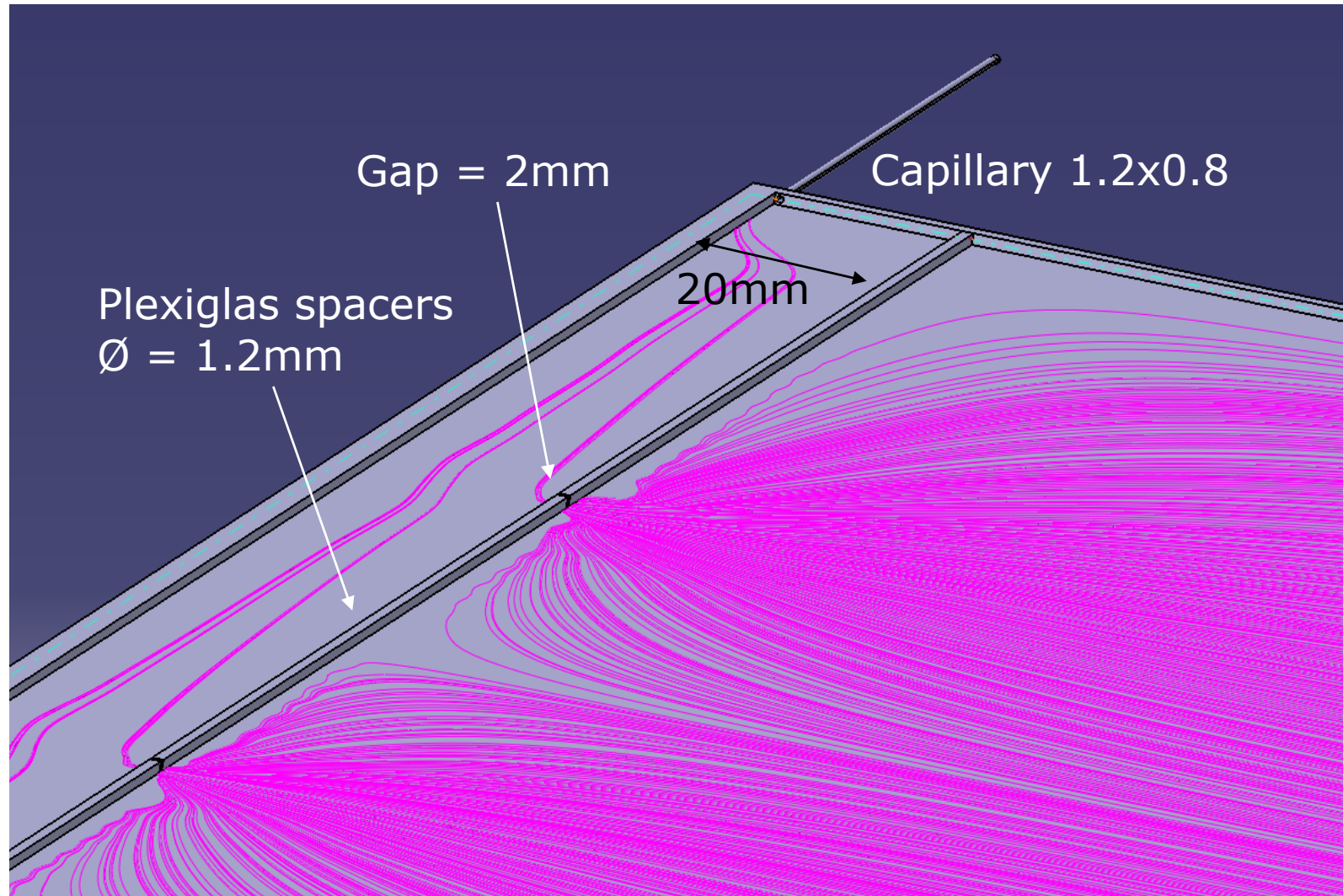


# Gas Tightness

- Closed chamber design makes chambers sensitive to overpressure → leaks
- 1 mbar overpressure  $\equiv$  10 kg/m<sup>2</sup>
- Attempted to make chambers more robust by replacing small fraction of ceramic balls with cylindrical spacers (much larger gluing area) → failed
- Now trying to reduce  $\Delta p$  by increasing surface area of outlet capillaries (multiple capillaries)
  - Successful at SPS Testbeam : no leak in vertical position without HV

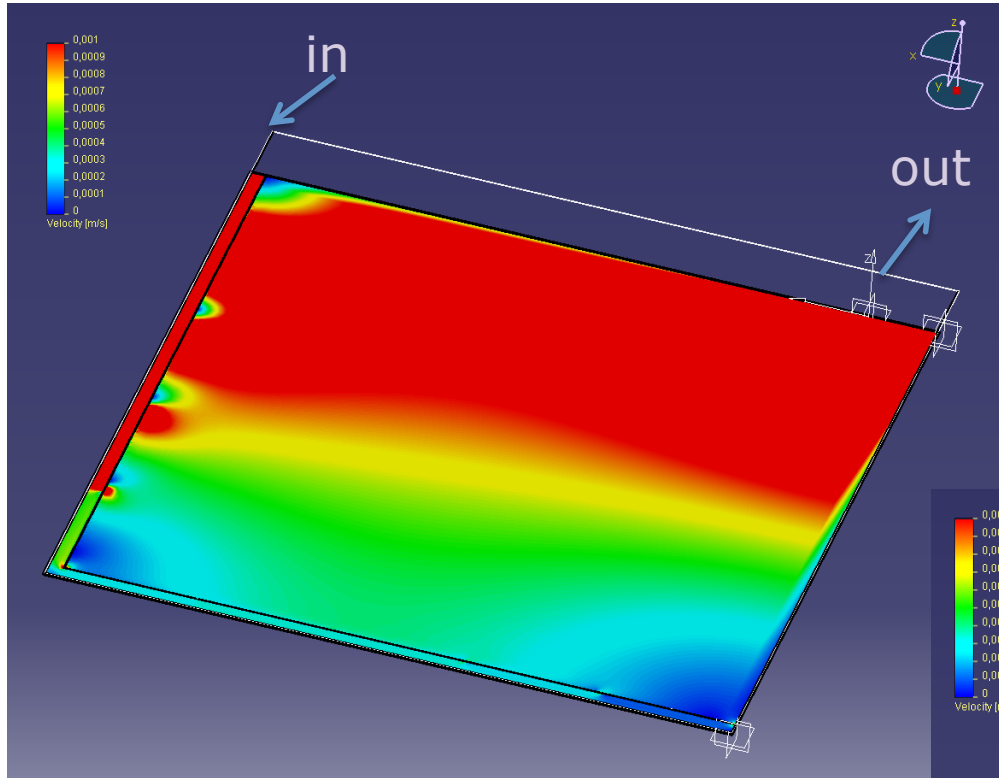
# Gas distribution

May be an issue for large area, very thin chambers





# Gas circulation simulations (1)

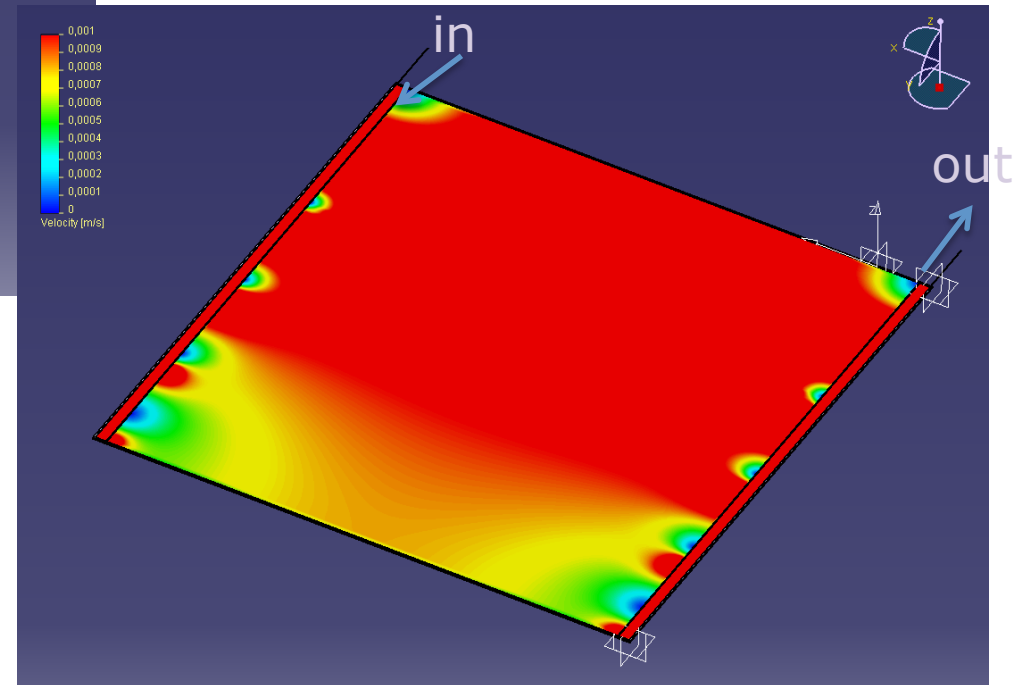


Velocity – old chamber design

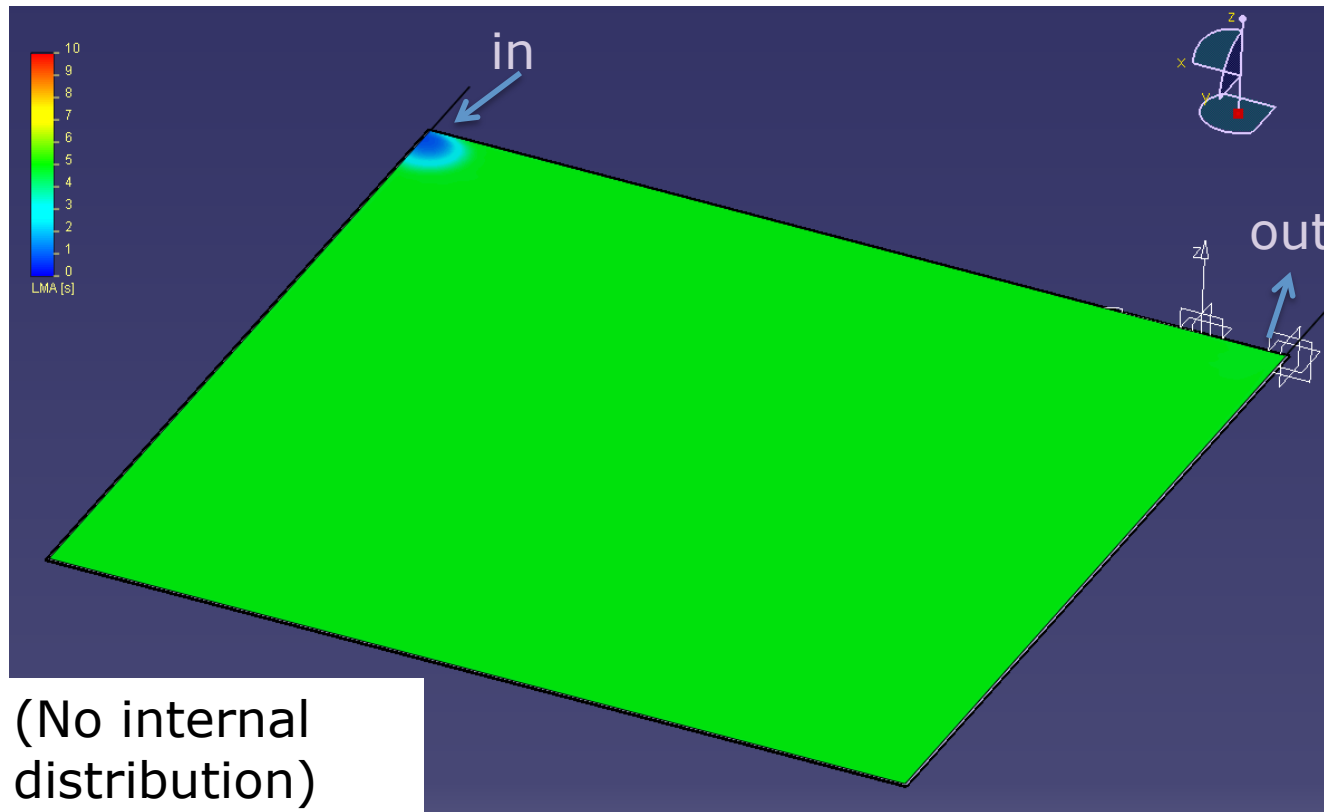
Max. (red)  $\sim 1\text{mm/s}$

Diffusion not included in simulation

Velocity – new chamber design



# Gas circulation simulations (2)



**Least mean age:** time for gas to reach any given point in chamber

- Includes diffusion effects (seems to dominate)

Suggests gas reaches almost all areas of chamber within  $\sim 5s$

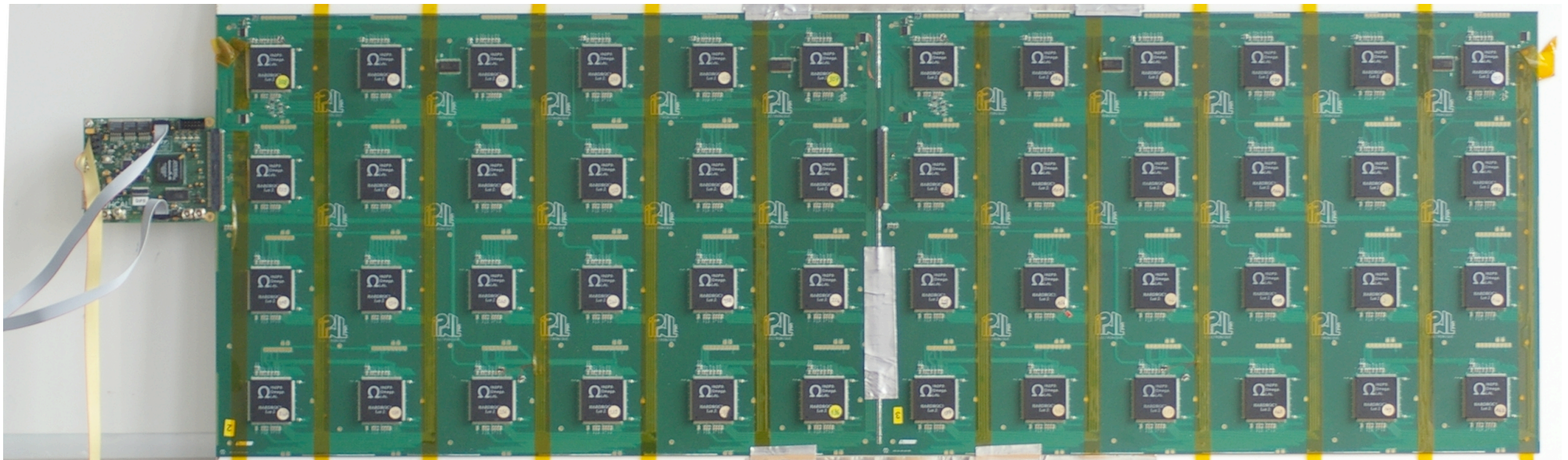
- Is channeling of gas within chamber really necessary?

# Gas system

- Unable to use isobutane in latest test beams due to flammable gas safety issues with Lyon gas mixer
- Propose new system which will also serve for 1m<sup>3</sup> tests
  - 40 channel mixer
  - ATEX certified mass flow meters
  - Fine outlet pressure regulation
- Recent discussion with CERN DT1 gas group which could build the system

# Readout electronics status for M<sup>2</sup> detector

- 8 PCB of 50X33.3 cm<sup>2</sup> were conceived and produced
- 8-layer, class 6 (buried vias)
- 6 were equipped with hardroc1 (plastic packaging) → 144 ASICs
- PCB are connected 2 by 2 using zero resistor



DIF

12

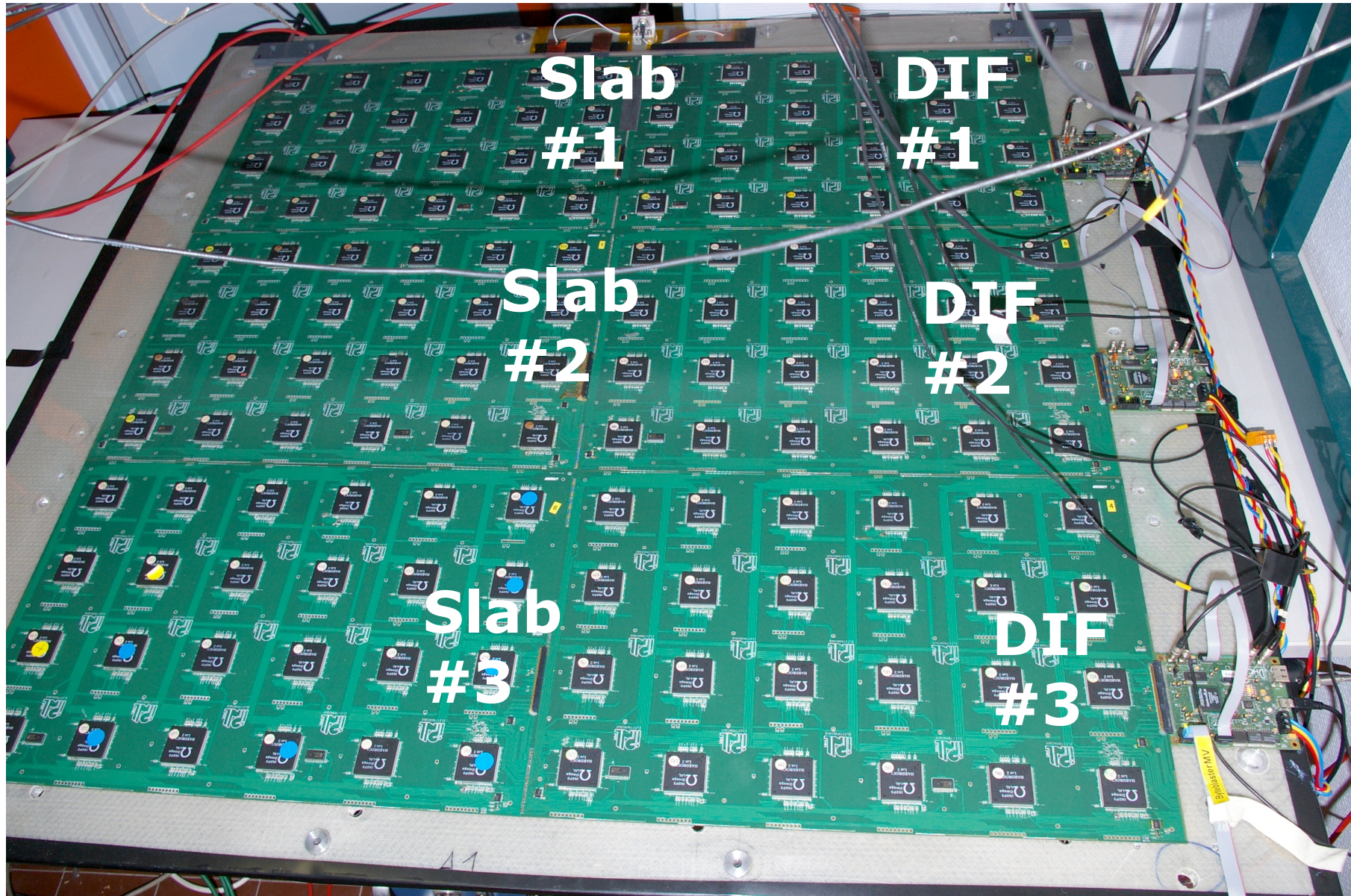


Slab 1

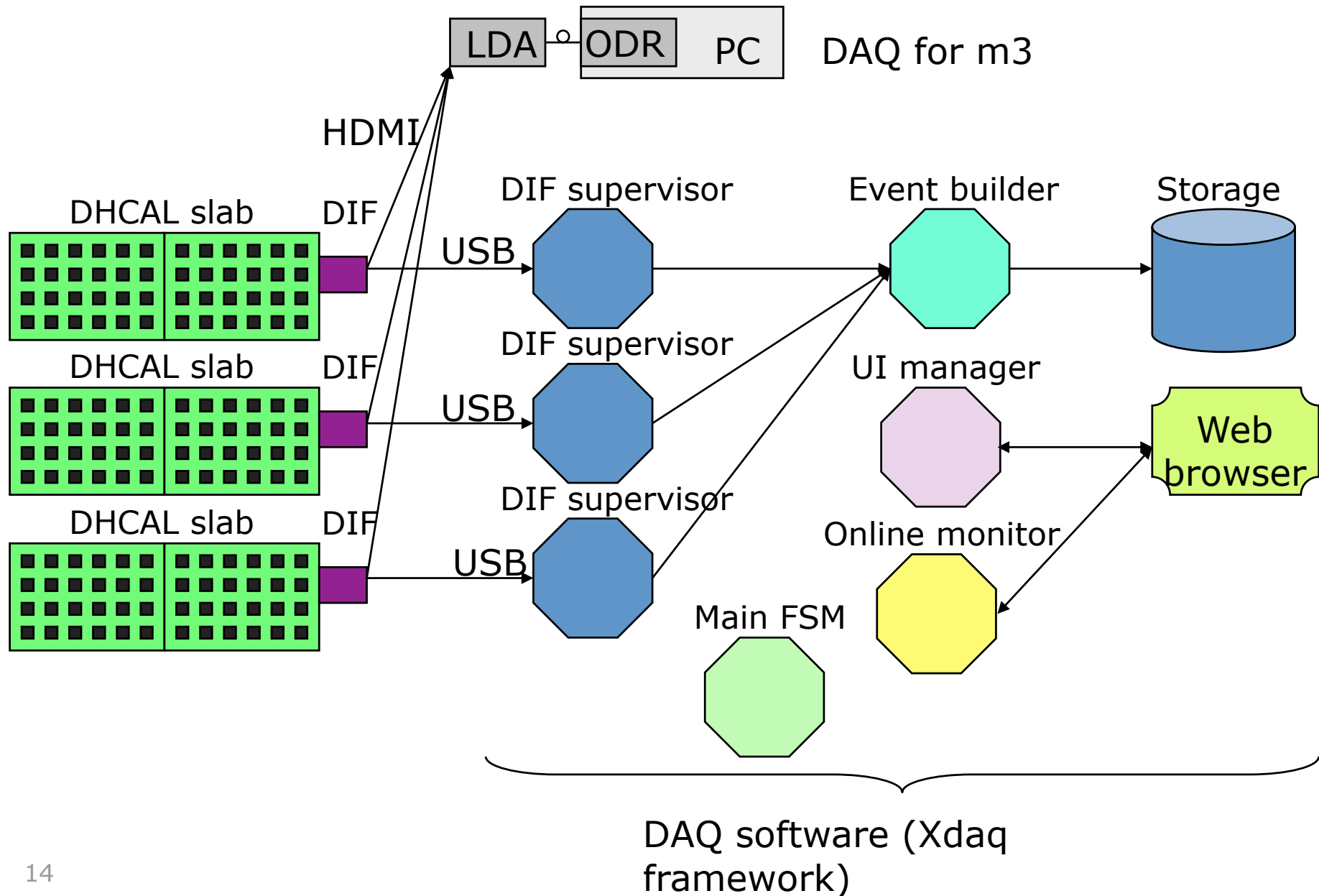


Slab 2

# 1 m<sup>2</sup> of equipped detector



# DAQ Schematic view



# DAQ capabilities

## **3 modes to operate the DAQ :**

- *Manual mode* : all functions, commands and registers of one or several DIF(s) are accessible one by one (mainly used for debug purpose)
- *Semi Automated mode* : More complex functions of one or several DIF(s) can be performed, ie send slow control, start acquisition
- *Automated mode* : All behavior is driven by main finite state machine

## **2 trigger modes :**

- *Standard mode* :
  - Hardrocs store data on the external trigger
  - Data are sent to the DAQ PCs when RAM is full
- *Beamtest Mode* :
  - Hardrocs store all valid data (internally autotriggered)
  - Hardrocs stop storing on external trigger (i.e. common stop) and send data to DAQ PCs

The screenshot shows a web browser window titled "ManualControl" with the URL `http://134.158.142.44:1972/urn:xdaq-application:lid=20/`. The interface is divided into several functional panels:

- FTDI support:** Includes buttons for "ResetFT245", "FT245GetStatus", "Refresh", "Close", and "SendToOne".
- Register access:** Features input fields for "Address (Hex)" and "Data (Hex)", both set to "0", and "Read" and "Write" buttons.
- Command access:** Includes a "Command (Hex)" input field set to "0" and a "SendCommand" button.
- Reset access:** Contains buttons for "ResetFPGA", "ResetASIC", "ResetBCID", "ResetSC", "ResetSR", "ResetSCReport", and "ResetDIFCpts".
- ASIC power supply:** Lists power components: "PowerAnalog", "PowerDAC", "PowerSS", "PowerDigital", "PowerADC", and a "RefreshASICPowerStatus" button.
- Detector Power control:** Includes "AVDDShdn", "DVDDShdn", and "RefreshSlabPowerStatus" buttons.
- Slow control:** Shows "Load OK CRC OK" status, a dropdown menu for "FT101009", and buttons for "ConfigureSLC", "ReadSLCStatus", and "RefreshNbOfASICs". Below are radio buttons for channels 1 through 48.
- Detector Monitoring:** Features sliders for "DIF Imon gain" and "Slab Imon gain" (both at 50), a "Monitored channel" dropdown set to 3, a "Sequence function" dropdown, and "ConfigureMonitoring" and "EnableMonitoring" buttons.
- Numerical readout:** Includes a mode selector (Standard mode / Manual), a "ConfigureNumericalReadout" button, and buttons for "StartAcquisition", "SendExtTrigger", "SendRamFullExt", "StartReadout", "SendReadout", "ReadoutData", and "DigitalFlushFIFO".
- Analog readout:** Includes a "Timer Hold Register" input field set to 5, and buttons for "StartAnalogAcq", "SendAnalogTrigger", and "SetTimerHoldRegister".

At the bottom, there is a search bar with the text "Rechercher :", navigation buttons "Suivant" and "Précédent", and checkboxes for "Surligner tout" and "Respecter la casse". The status "Terminé" is displayed at the bottom left.

Low voltages also operated via the web interface



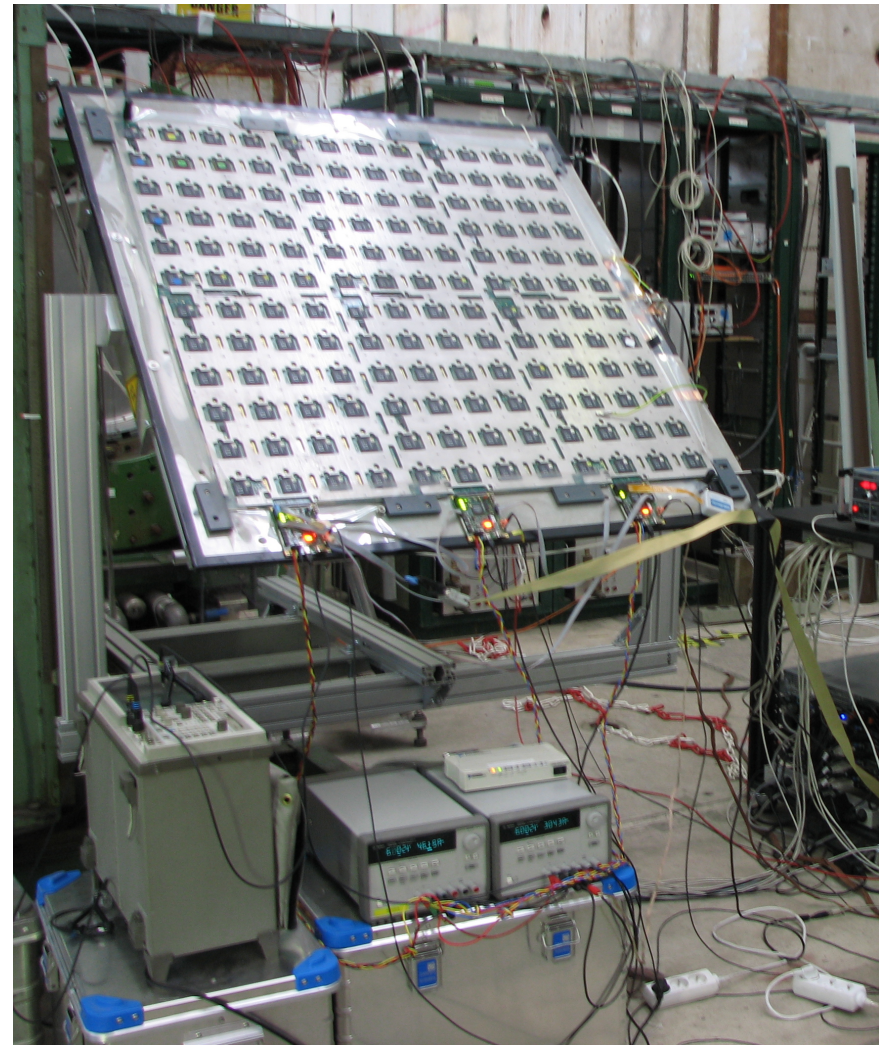
# Readout and DAQ in testbeam

Problems found and fixed (thx *G.Vouters*):

- DIF firmware updates
- XDAQ acquisition
  - 3 DIF synchronisation made possible

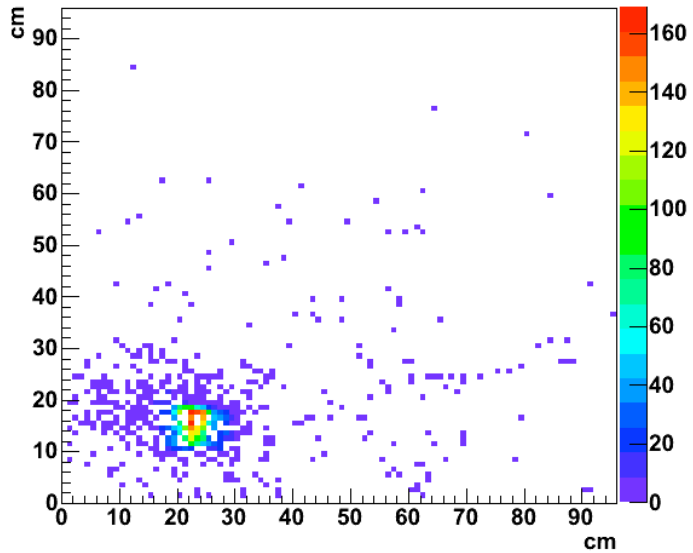
Data taking in 2 test beams:

- debugging at the PS in July with a Licron chamber
- Datataking at the SPS in August with a Statguard chamber.

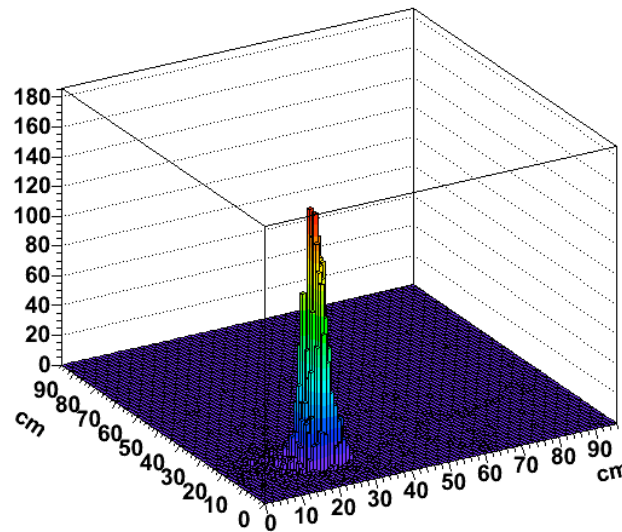


# Success @ SPS test beam

Beam profile in 1 m2 chamber



Beam profile in 1 m2 chamber



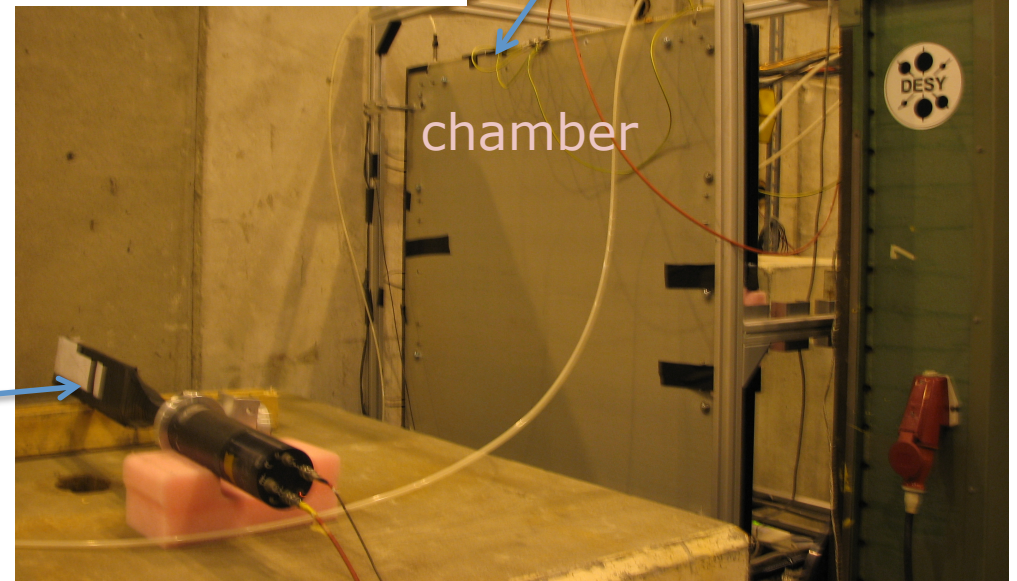
HV connection



Pads over (low) threshold

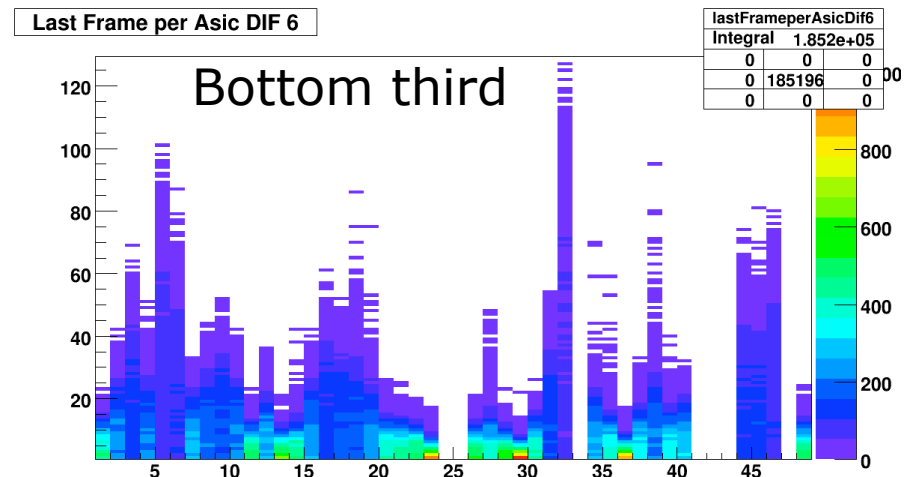
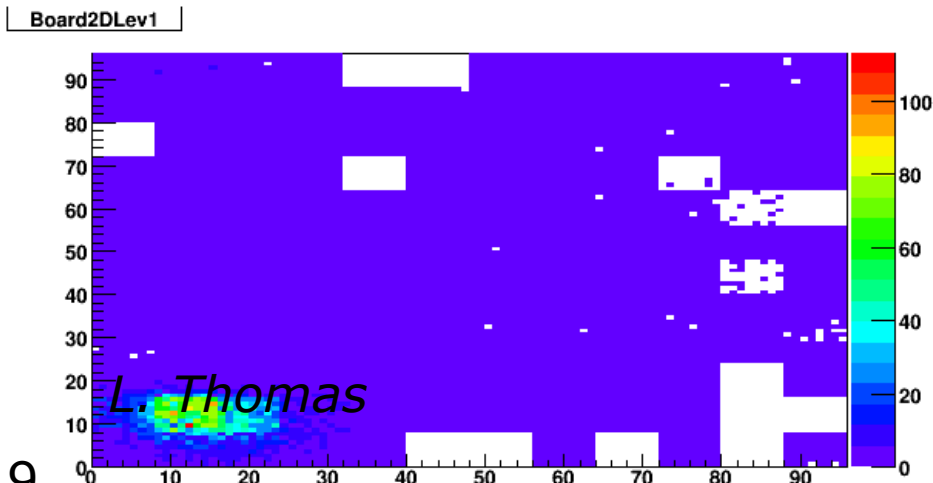
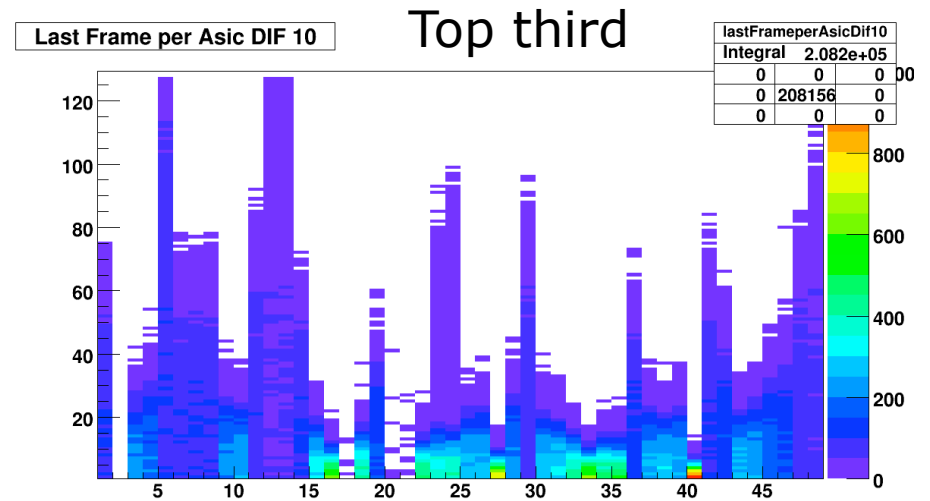
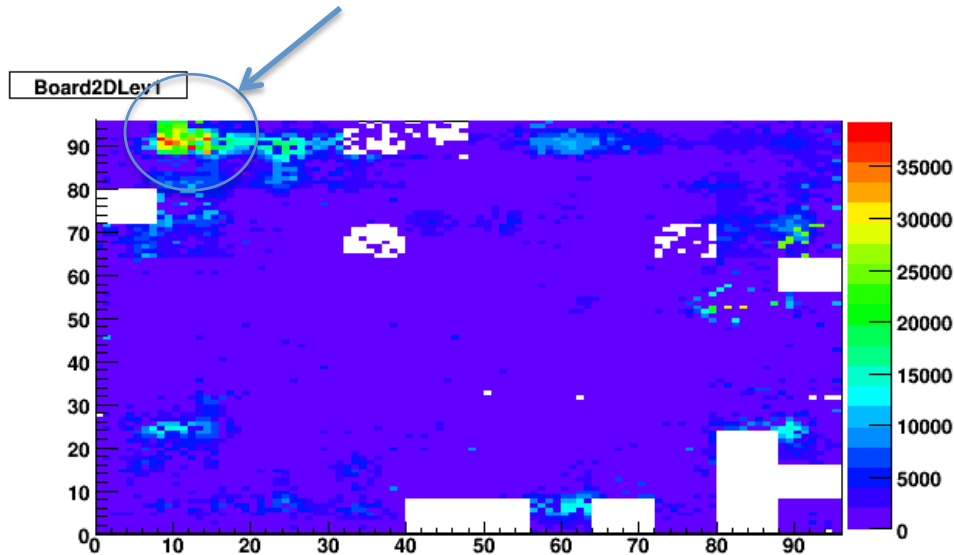
DAQ successful in testbeam mode  
 With 3 DIFs synchronised  
**Up to 93% efficiency**

pion /muon beam



# Some issues under investigation

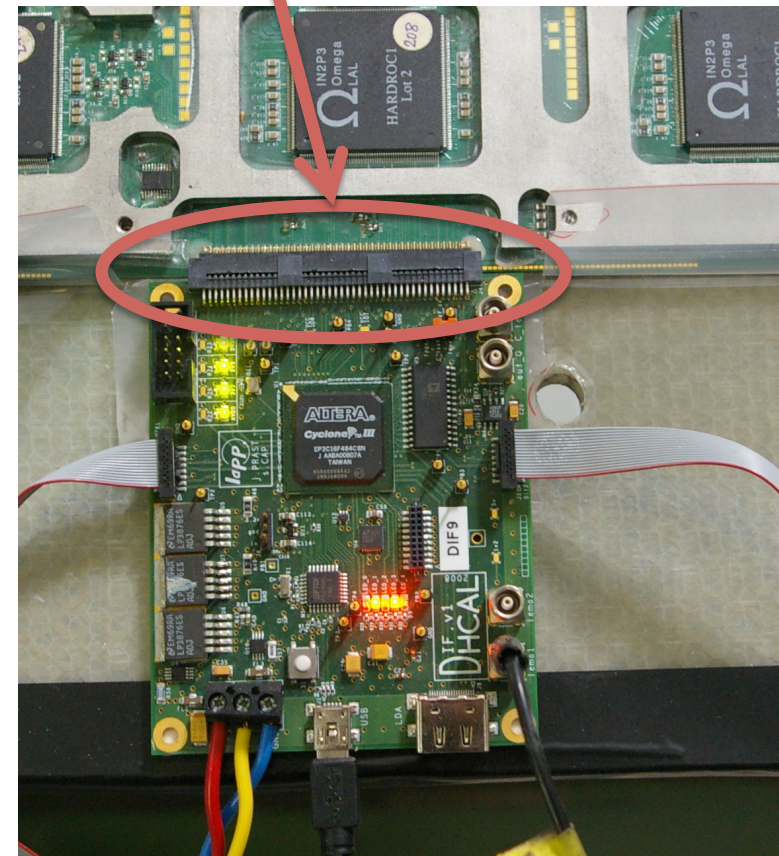
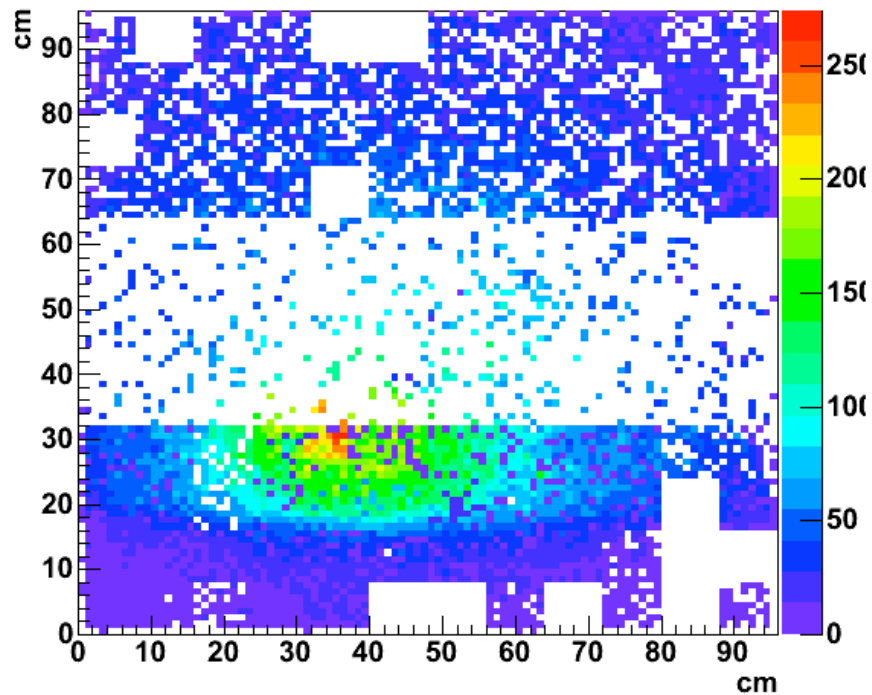
Some noise in the HV connector region



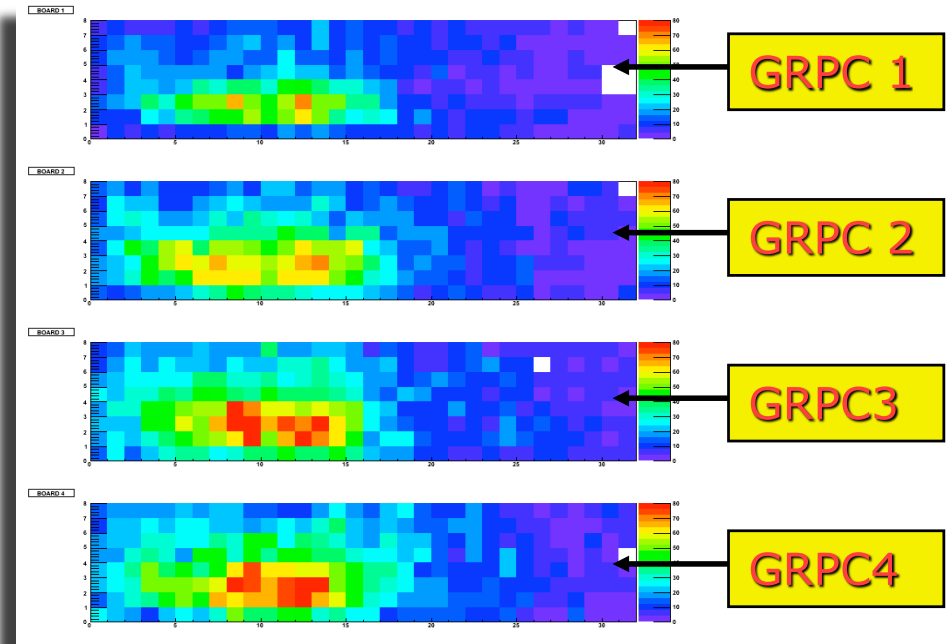
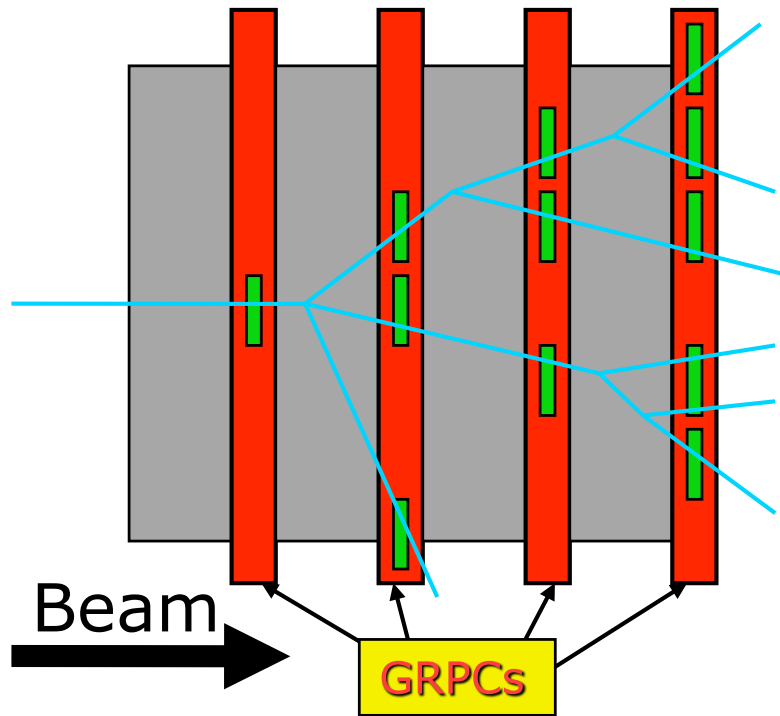
# Fragile connections

- DIF connector very fragile and do not withstand multiple connections

Beam profile in 1 m2 chamber

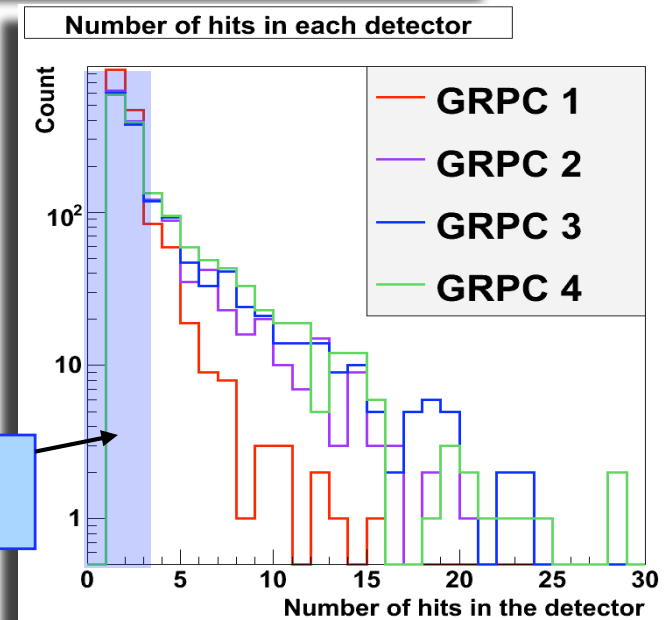


20 Flat kapton cable under development for next prototype



Hadronic showers are **mostly uncontained** in Mini DHCAL but these profiles give a **first idea** of shower development, and energy deposition.

Muon contamination area

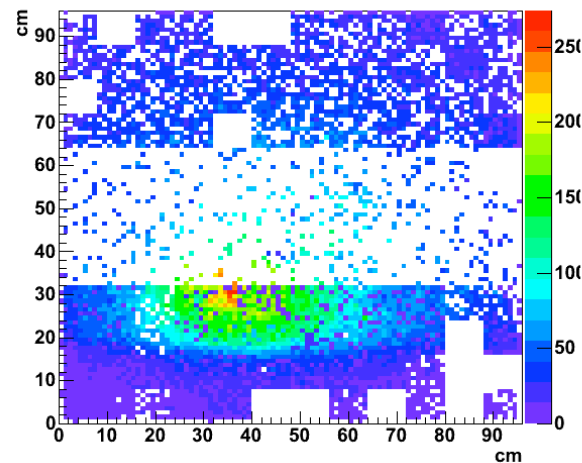


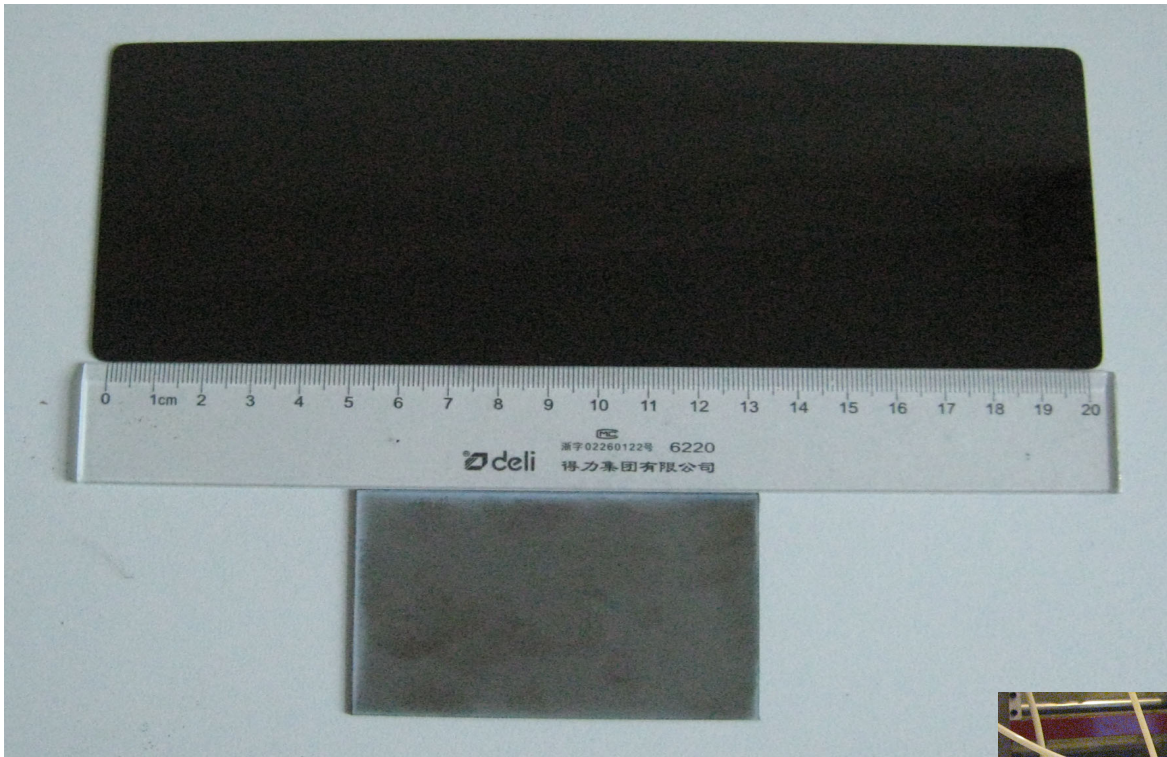
# Physics Programme

- 1 to 6 Lead walls
- 30 to 150 GeV pion energies
- Analysis of the data in terms of physics ongoing



Beam profile in 1 m2 chamber





Semiconductive glass

210mm\*70mm\*0.7mm

$\sim 10^{10} \Omega \cdot \text{cm}$

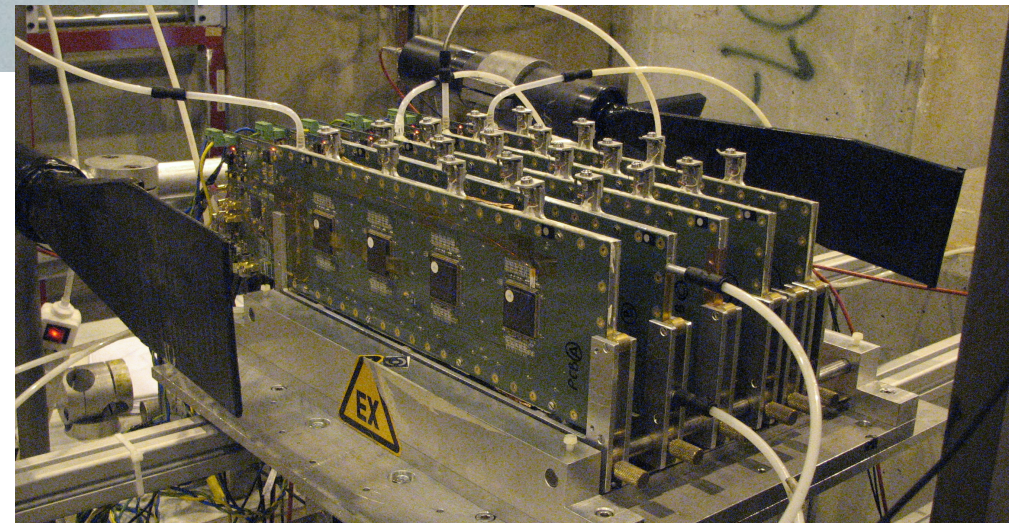
**Rate: >26 kHz/cm<sup>2</sup>**

Semiconductive ceramics

80mm\*50mm\*1mm

$10^6 \sim 10^9 \Omega \cdot \text{cm}$

2 licron and 2 statguard 8x32cm<sup>2</sup> chambers built at IPNL with Chinese glass and tested with the SDHCAL electronics in the 2 summer TB at cern (See R.Kieffer's talk)

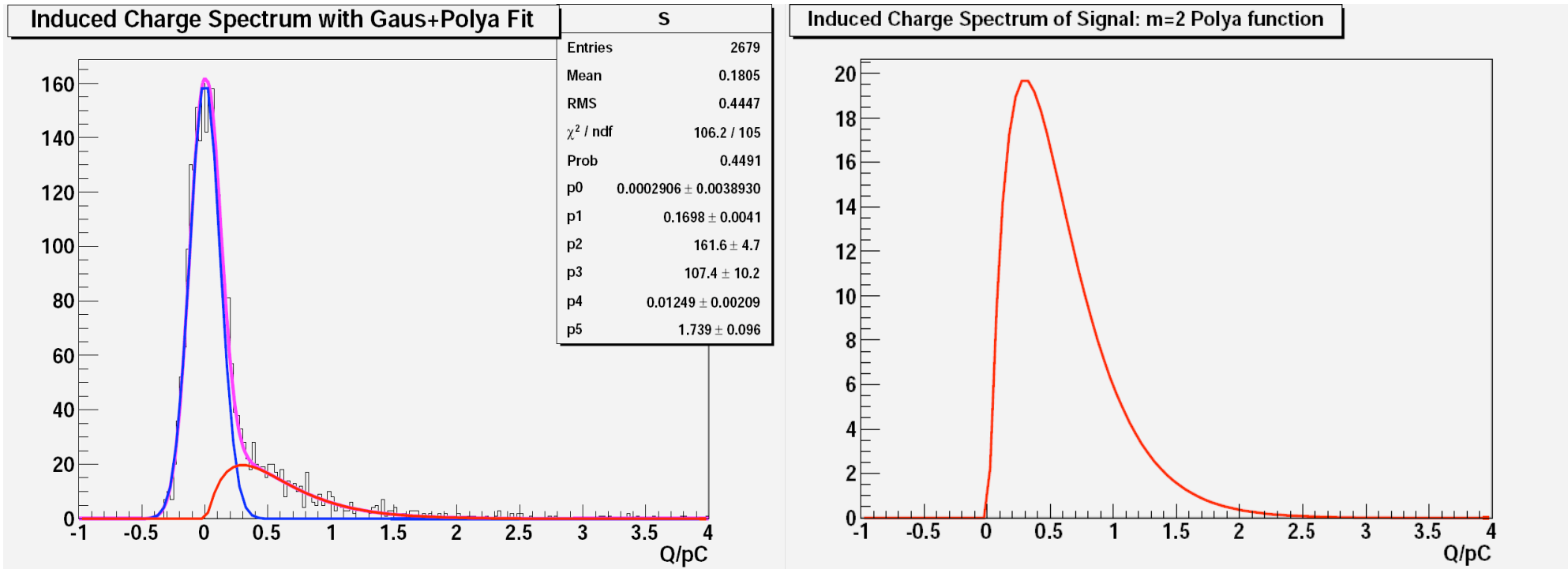




# Simulation Progress



# Fix $G_0$ with Experimental Input: Induced Charge of one Mip



Induced Charge Spectrum of  $\sim 2700$  cosmic evts;  
fit to a Gaussian Noise +  $m=2$  Scaled Polya Signal ( $\text{av} \sim 0.6 \text{ pC}$ )

1 Mip  $\sim n$  Ionization, then  $G_0 \sim 0.6/n \text{ pC}$ . Using a  $m=2$  Scaled Polya function to estimate the Induced charge for each ionization

# Estimate average energy needed for each ionization

Table 1

Properties of several gases used in proportional counters (from different sources, see the bibliography for this section). Energy loss and ion pairs per unit length are given at atmospheric pressure for minimum ionizing particles

Gas	Z	A	$\delta$ (g/cm <sup>3</sup> )	$E_{ex}$	$E_i$	$\gamma_0$	$W_i$	$dE/dx$		$n_p$ (i.p./cm) <sup>a)</sup>	$n_T$ (i.p./cm) <sup>a)</sup>
								(MeV/g cm <sup>-2</sup> )	(keV/cm)		
H <sub>2</sub>	2	2	$8.38 \times 10^{-5}$	10.8	15.9	15.4	37	4.03	0.34	5.2	9.2
He	2	4	$1.66 \times 10^{-4}$	19.8	24.5	24.6	41	1.94	0.32	5.9	7.8
N <sub>2</sub>	14	28	$1.17 \times 10^{-3}$	8.1	16.7	15.5	35	1.68	1.96	(10)	56
O <sub>2</sub>	16	32	$1.33 \times 10^{-3}$	7.9	12.8	12.2	31	1.69	2.26	22	73
Ne	10	20.2	$8.39 \times 10^{-4}$	16.6	21.5	21.6	36	1.68	1.41	12	39
Ar	18	39.9	$1.66 \times 10^{-3}$	11.6	15.7	15.8	26	1.47	2.44	29.4	94
Kr	36	83.8	$3.49 \times 10^{-3}$	10.0	13.9	14.0	24	1.32	4.60	(22)	192
Xe	54	131.3	$5.49 \times 10^{-3}$	8.4	12.1	12.1	22	1.23	6.76	44	307
CO <sub>2</sub>	22	44	$1.86 \times 10^{-3}$	5.2	13.7	13.7	33	1.62	3.01	(34)	91
CH <sub>4</sub>	10	16	$6.70 \times 10^{-4}$		15.2	13.1	28	2.21	1.48	16	53
C <sub>4</sub> H <sub>10</sub>	34	58	$2.42 \times 10^{-3}$		10.6	10.8	23	1.86	4.50	(46)	195

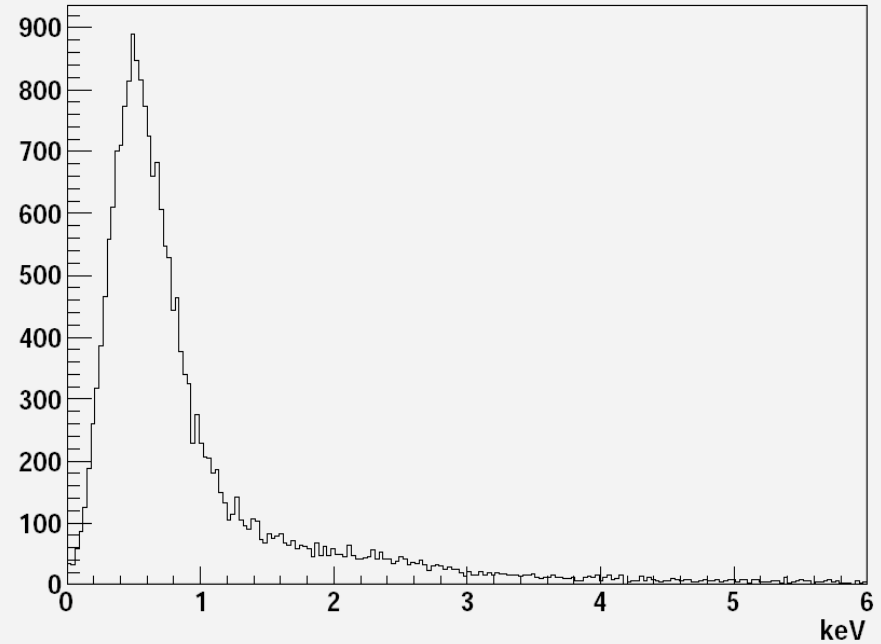
a) i.p. = ion pairs

Take  $E_{ion} = 35eV$

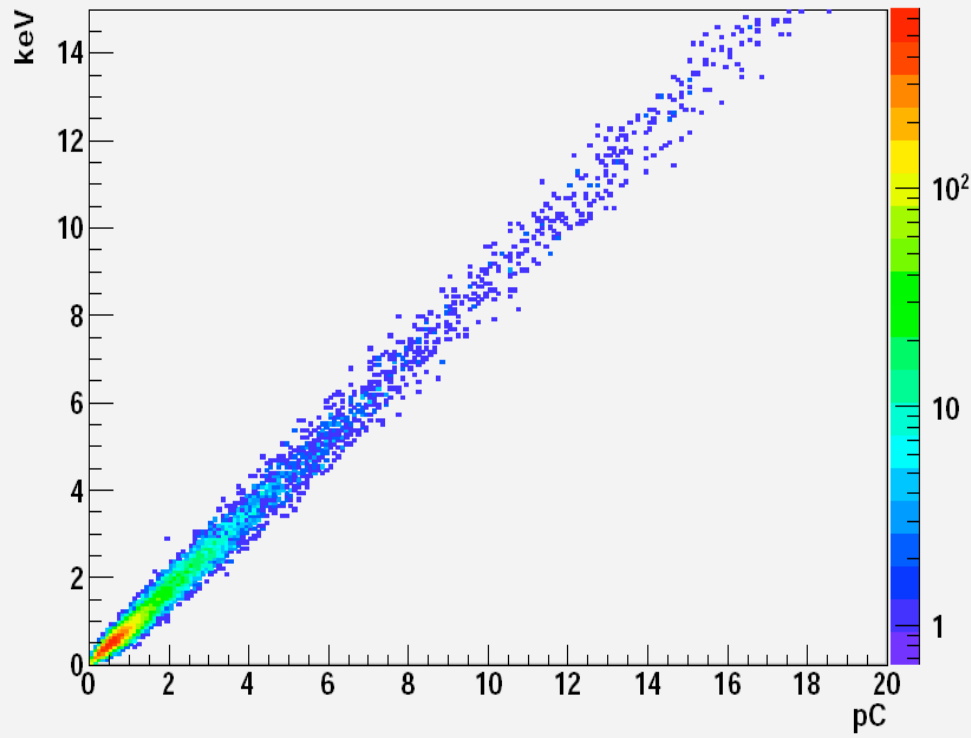


# Digitization with 1 GeV Muon

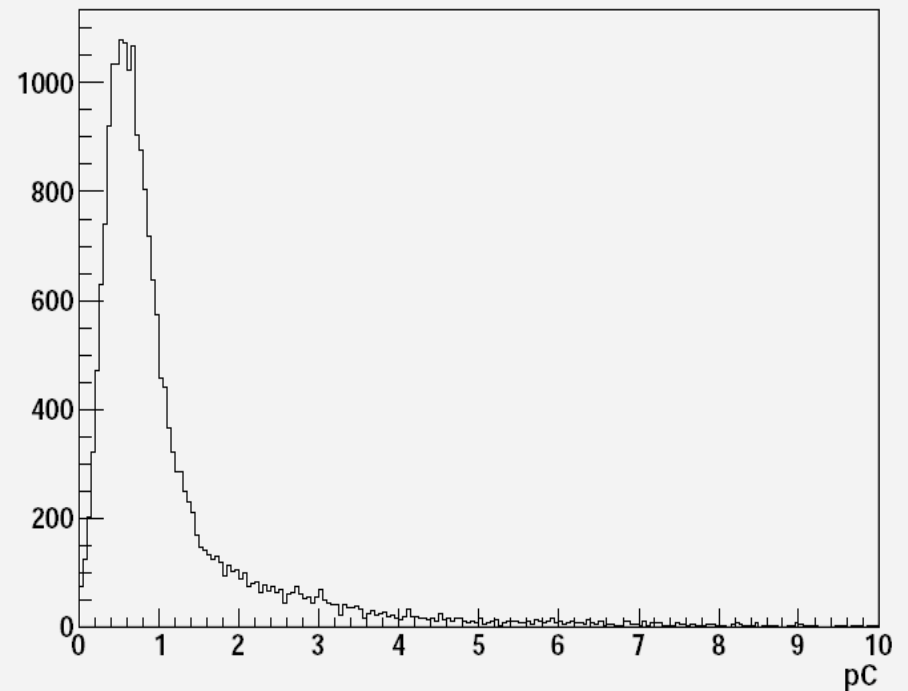
Hit Energy Deposition of 1GeV Muon (1k evts)



Induced Charge Vs Energy Deposition DHCAL Hits with 1 GeV Muon

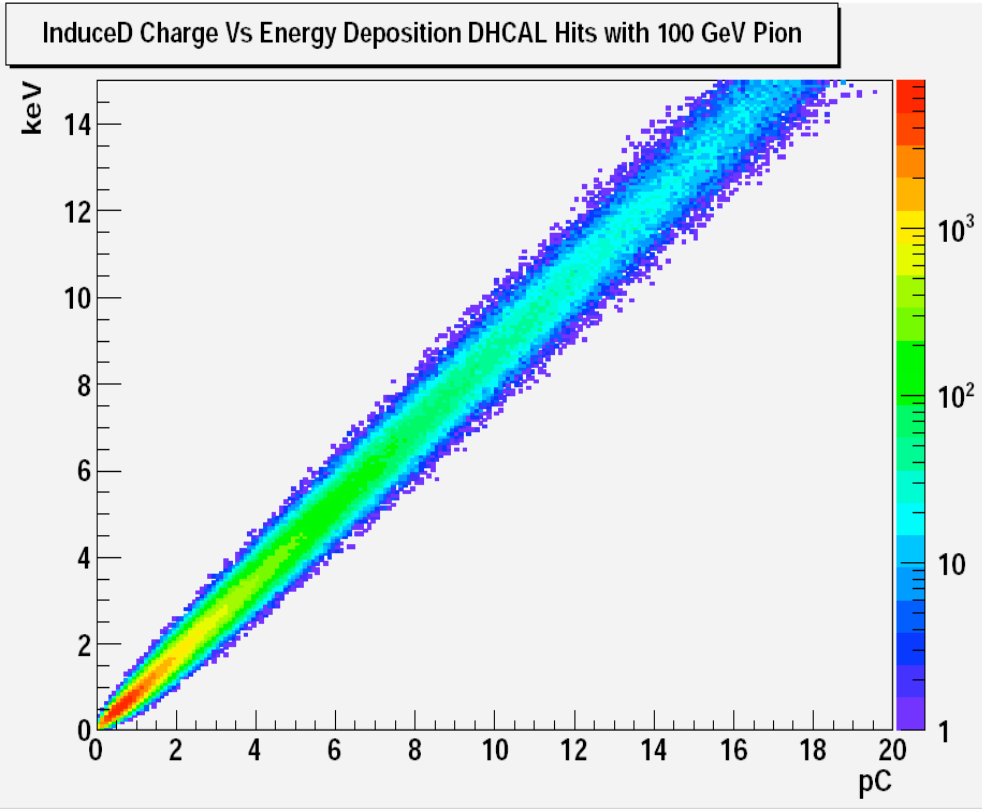
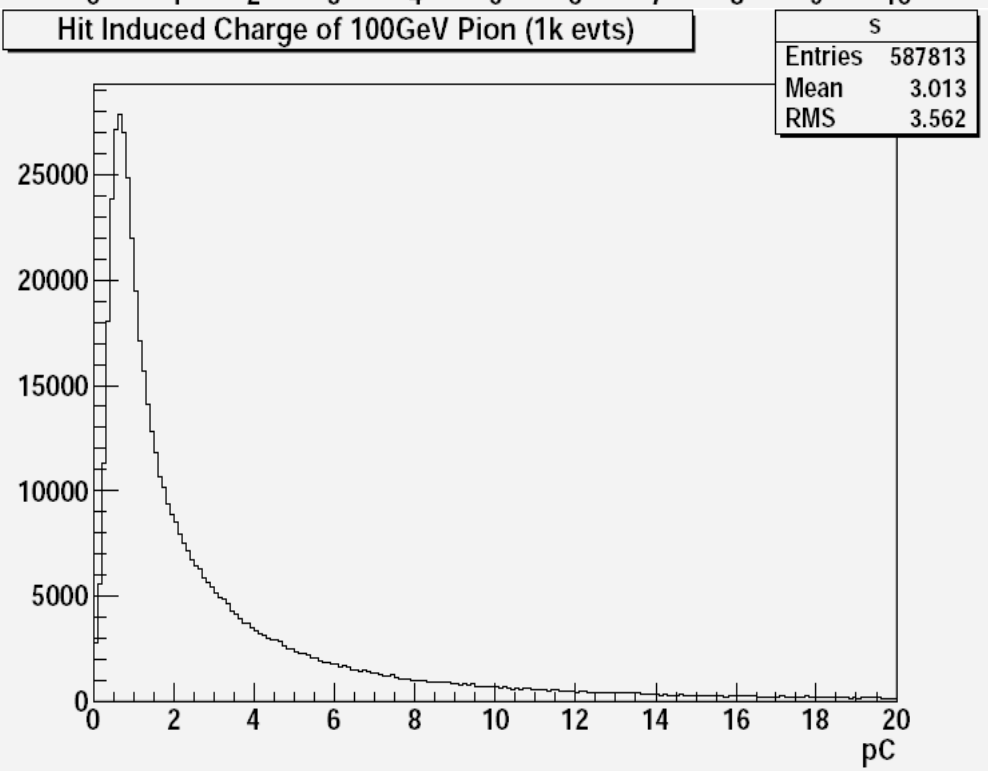
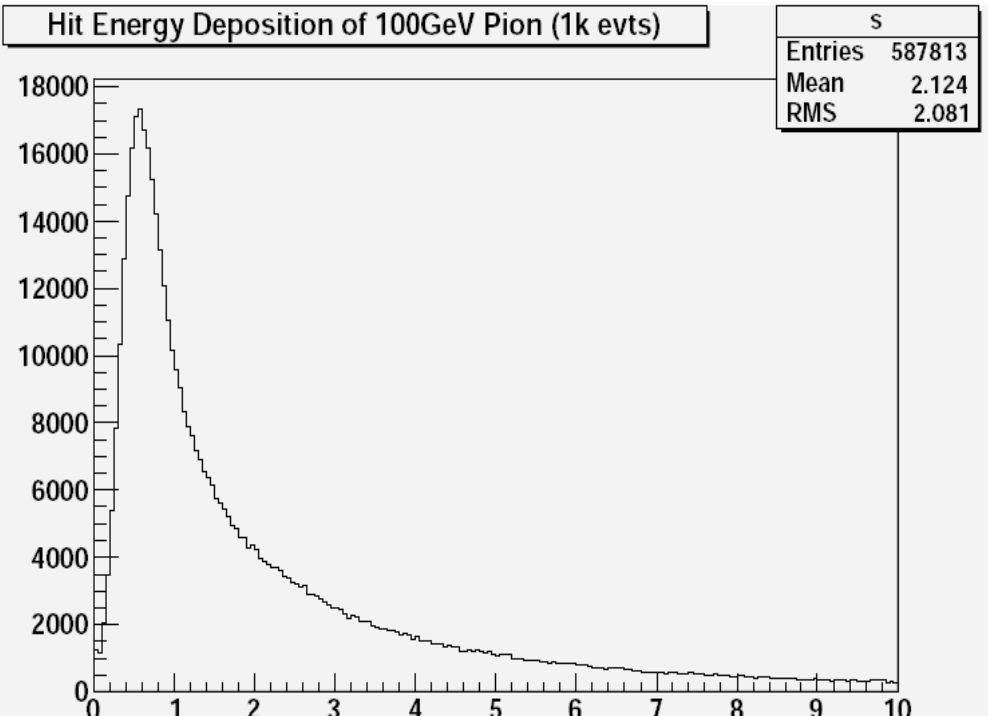


Hit Induced Charge of 1GeV Muon



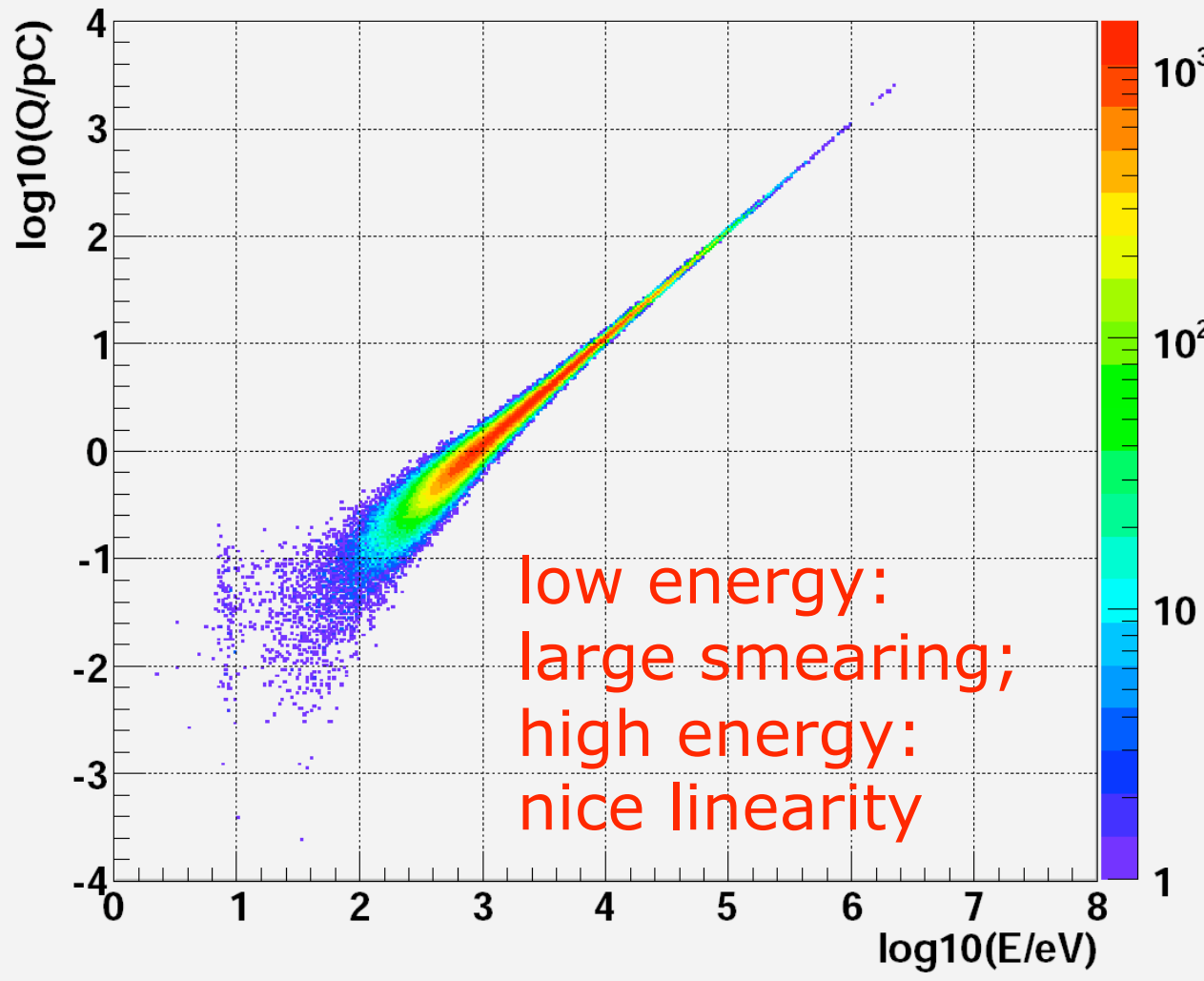


# Digitization with 100 GeV Pion



# Digitization with 100 GeV Pion:

Induced Charge Vs Deposited Energy (100GeV Pion)



## To do list:

- Taken into account the Saturation effect
- Threshold optimization study (**Important!**)
- Polish the software package & release as a MarlinReco module

# Conclusion

- Building ILC-like large GRPCs is now a controlled technique
- Electronics readout for 1m<sup>2</sup> is debugged and works for Hardroc 1 and Hardroc 2
- Simulation and threshold optimization (see S. Mannai's talk) progress in parallel
- Mechanical structure to hold GRPC+ equipped PCB has been successfully used in testbeam.
- Another equipped 1m<sup>2</sup> with HR2 is under preparation
- Many thanks to everyone @ CIEMAT, Ghent, IPNL, LLR, Louvain, Tsinghua, Tunis for the help in preparing this report